

# Fab Investment Outlook and The Surge of China

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# Outline

- 2018 Outlook and Drivers
- Fab Investment Outlook
  - Record spending
- The Surge of China
  - New fab projects
  - Capacity projection
  - Memory and Foundry
- Summary



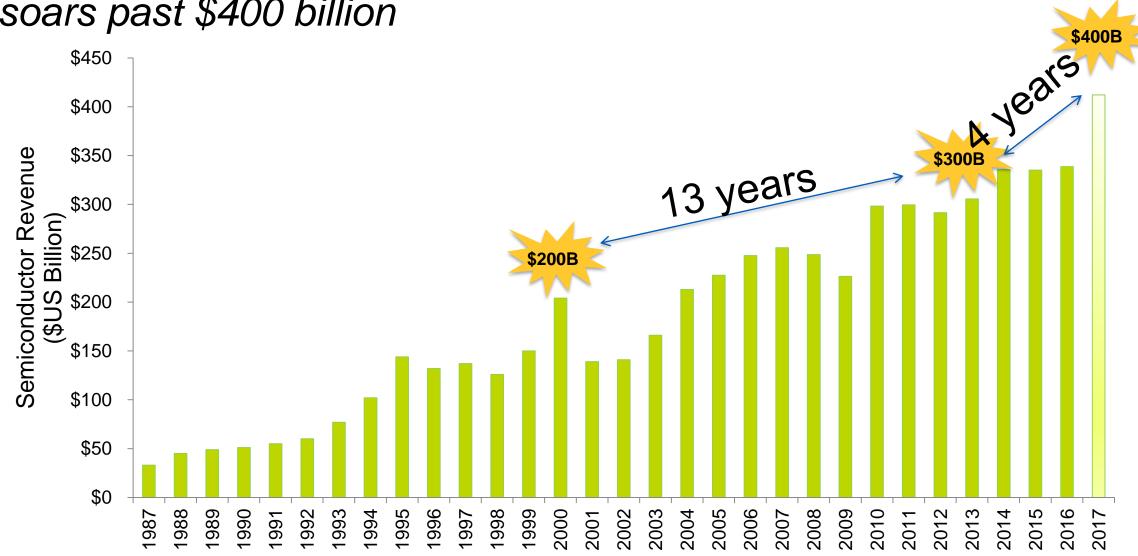
# 2018 Outlook and Drivers





# **Semiconductor Industry Outlook**

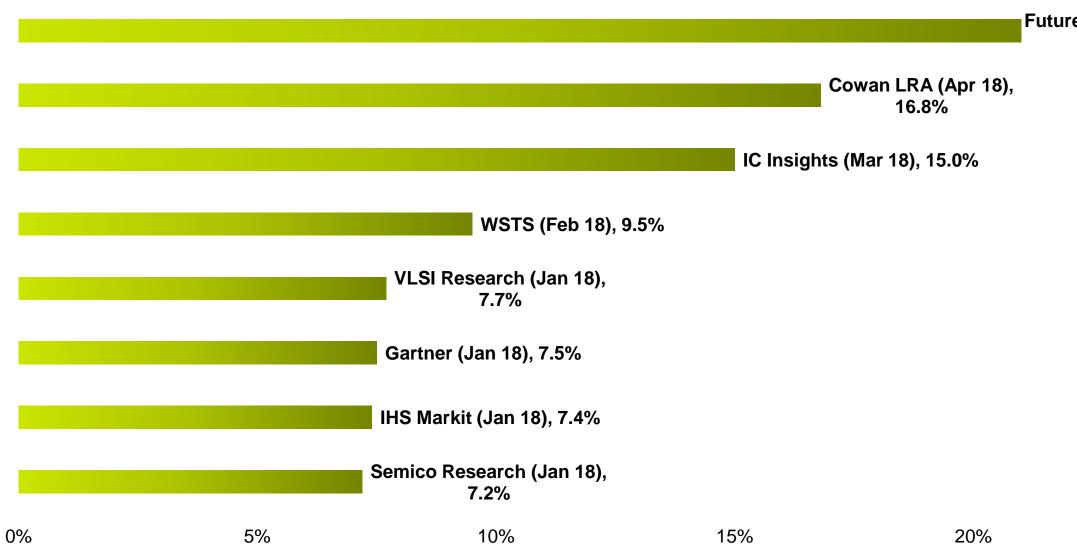
## 2017 soars past \$400 billion



Source: SIA/WSTS historical year end reports, WSTS 2018 Forecast



## 2018 Semiconductor Forecasts





## Future Horizons (Jan 18), 21.0%

25%

Source: SEMI April 2018

## Industry Trends and Growth Drivers

Numerous Applications Driving Growth Through 2025



- Robust volume shipments and higher ASPs for Memory are driving strong 2017 revenue growth.
- Storage, industrial, wireless, and automotive applications also contributing to strong 2017 growth.
- Connectivity, data centers, communications, automotive, and advanced software spurs strong demand through 2025. .

*	Semiconductor value
**	Network/Devices
***	<sup>r</sup> Market Size

Source: SEMI Industry Strategy Symposium, 2017



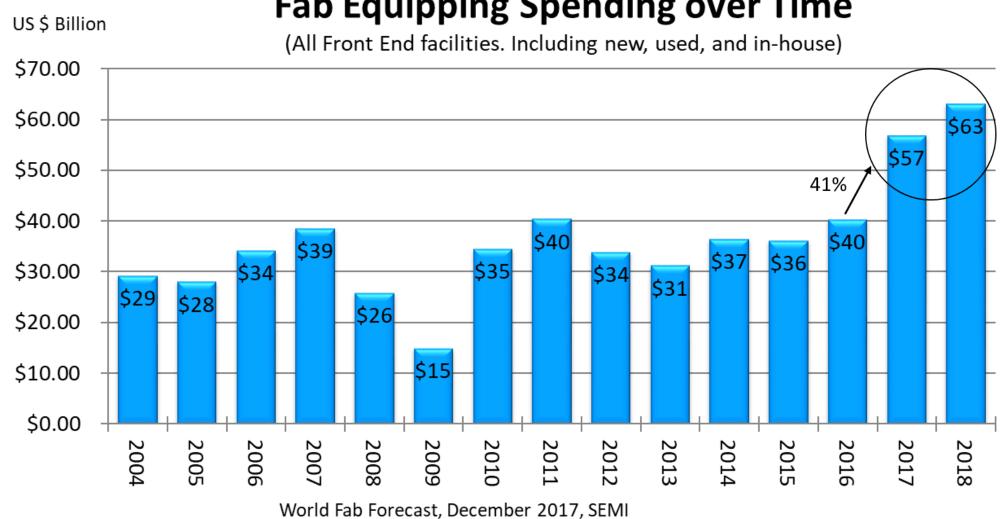
Virtual Reality (VR) Augmented Reality (AR) Al Artificial Intelligence (AI)

# Global Fab Investment Outlook





# 40% Increase in 2017

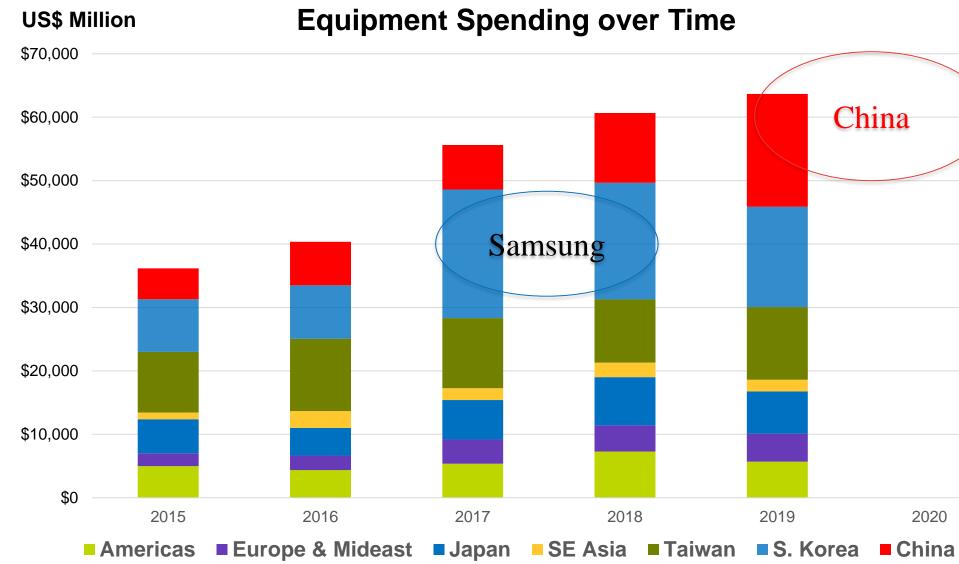






# **Fab Investments**

## Growth is likely to continue beyond this year

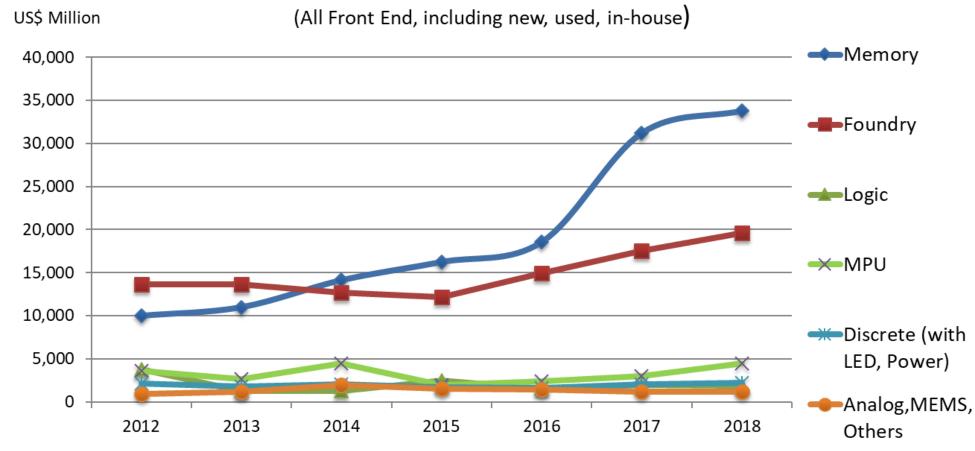


Source: SEMI World Fab Forecast, March 2018



# Fab Spending by Product Types Led by Memory and Foundry

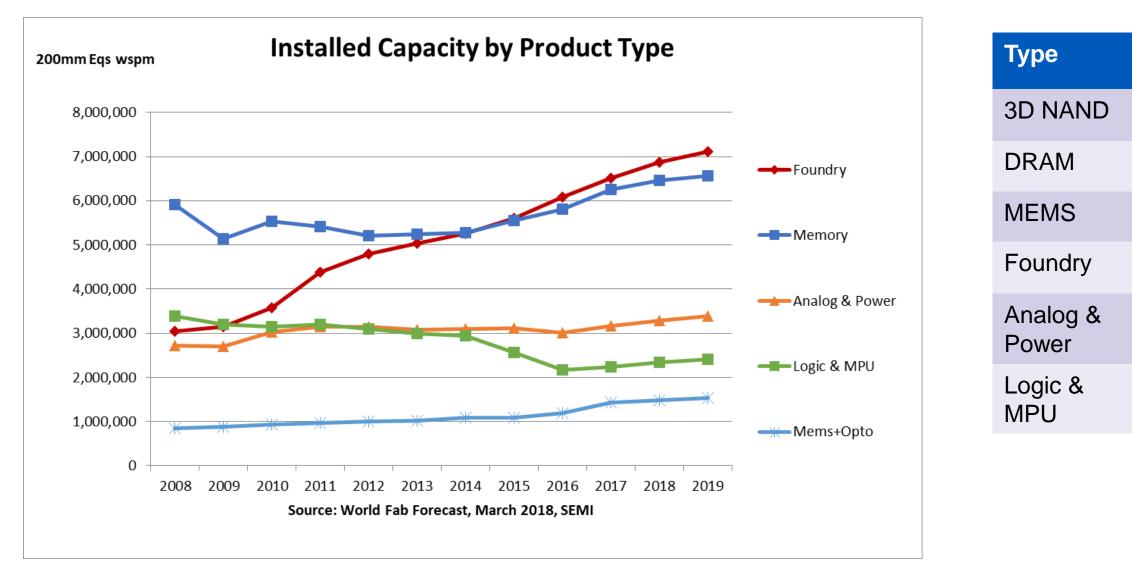
## Fab Equipment Spending by Product Type



Source: World Fab Forecast reports, December 2017, SEMI



## **Capacity Trend by Product Types** 3D NAND, DRAM, Foundry and MEMS add more new capacity





2018	2019
46%	20%
5.5%	5.7%
7.8%	3.8%
5.4%	3.5%
4.1%	3%
4.5%	3%

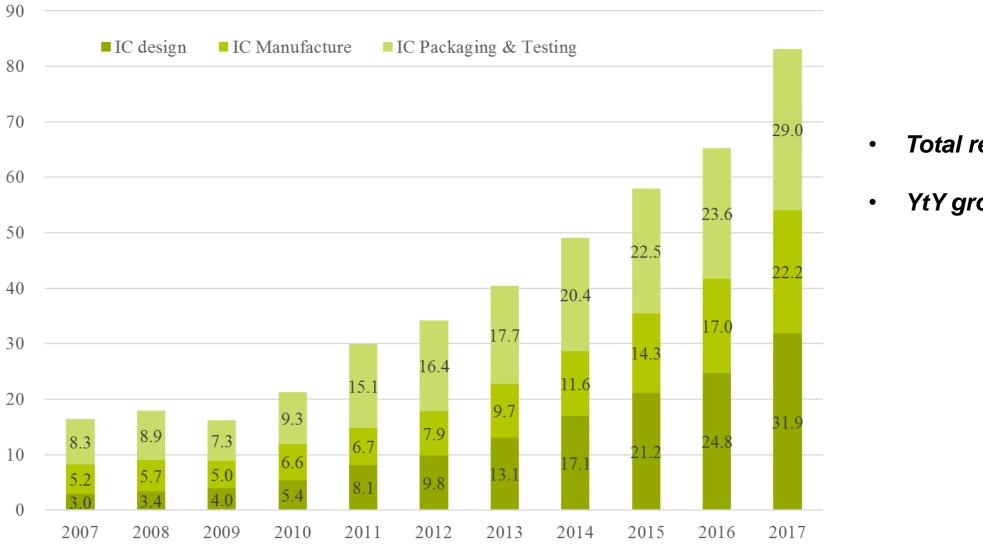
# China Investment





## **China's Domestic IC Industry** Undergoing Dramatic Growth

China IC Industry Revenue (B\$)

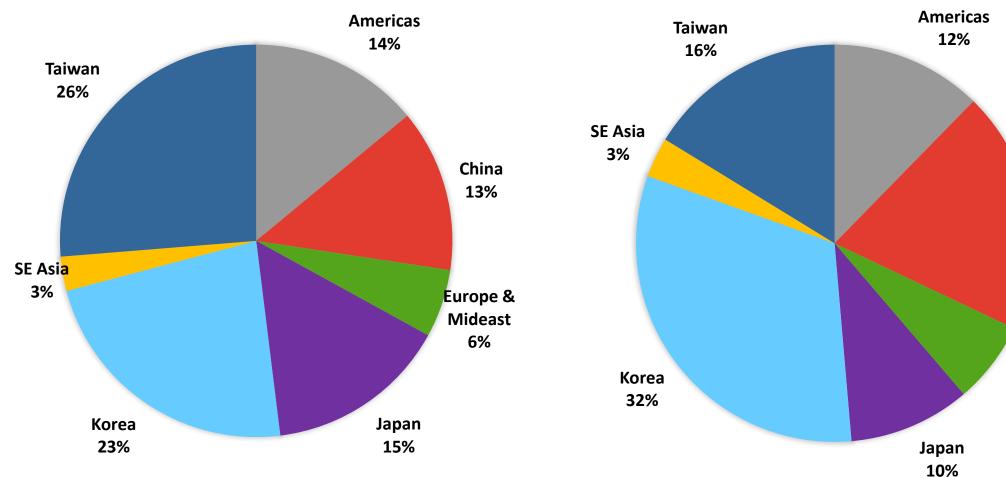


## Total revenue reached \$83.1B

## YtY growth rate is 27%

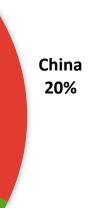
## Fab Equipment Spending by Region China to become Top 2 Spender in 2018/2019

2015 FAB EQUIPMENT SPENDING US\$36 BILLION 2018 FAB EQUIPMENT SPENDING US\$63 BILLION



Source: SEMI World Fab Forecast, December 2017



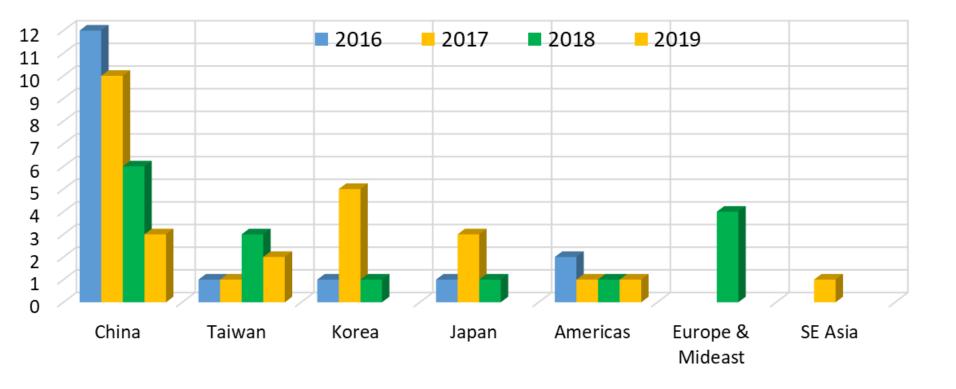


Europe & Mideast 7%

## New Fab Projects on the Rise - *China leads the way*

## **New Facilities & Lines Starting Construction**

(Front End, all probabilities, excluding LED, EPI, R&D)



Source: World Fab Forecast report (December 2017, SEMI)

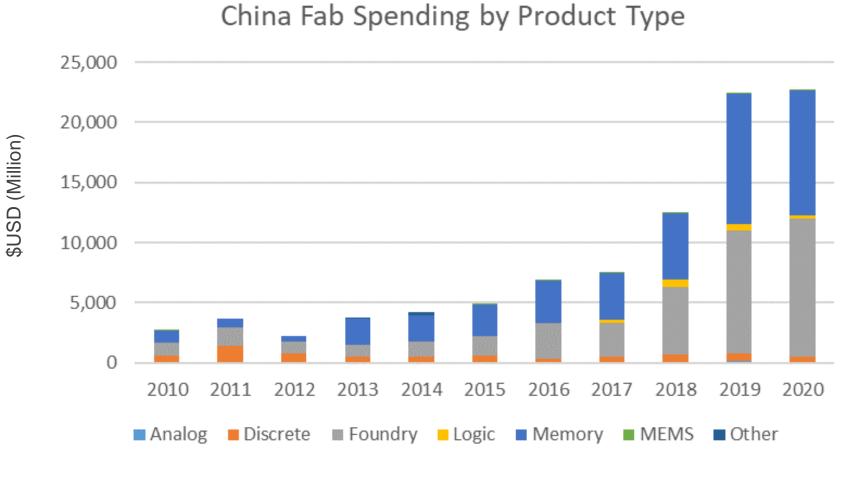
- 19 new fab projects in ● China from 2017 on
- Out of 10 upcoming Majority (7) are from **China-owned entities**



# 300mm projects in China,

## Surging China Fab Investment – Foundry & Memory Lead

## **Key Spending Projects**



Source: SEMI World Fab Forecast, December 2017

## 2017

- Intel Fab 68 upgrade to 3D NAND
- SK Hynix C2
- UMC Fab 12X
- SMIC B2

## 2018

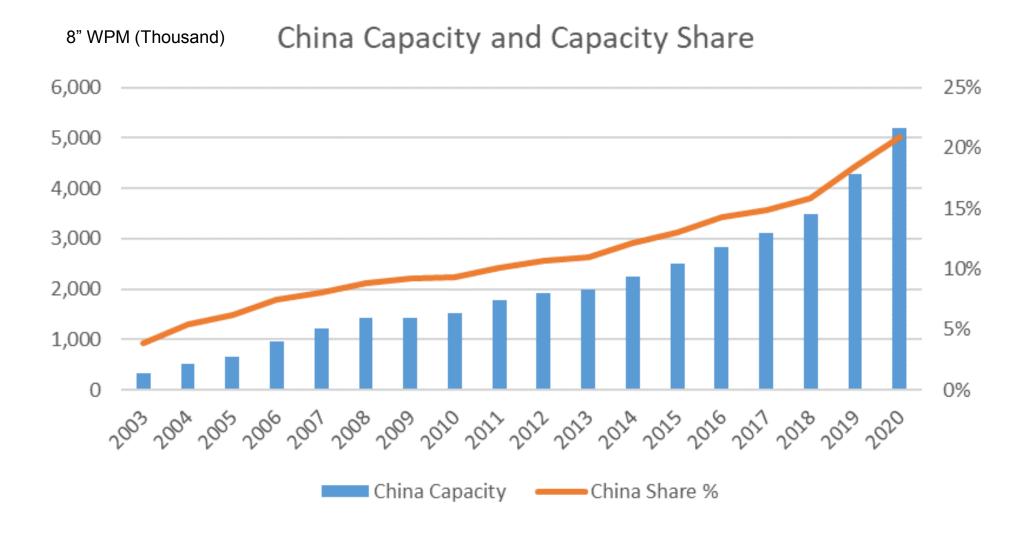
- Intel Fab 68 Phase 2
- Yangtze Memory Technology (Wuhan)
- **TSMC Nanjing Phase 1**
- Globalfoundries Chengdu Fab 11
- Hua Li Micro Fab 2
- Fujian Jin Hua DRAM .

## 2019/2020

- Tsinghua Unigroup (Nanjing) and ٠ Samsung Xian phase 2
- SK Hynix C3 •
- SMIC new Shanghai fab
- Hefei Chang Xin Memory •



# The Rising Share of China Capacity Strong growth from 2016 to 2020

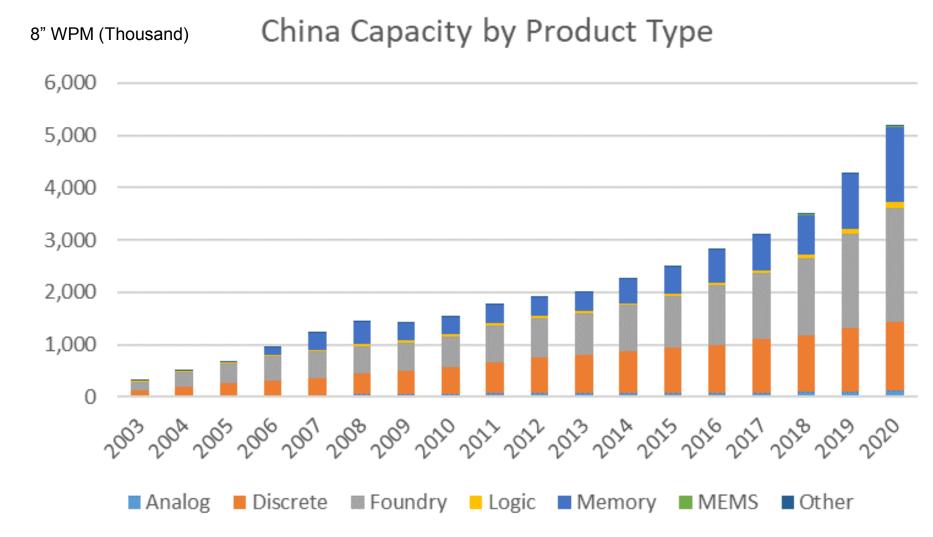


Disclaimer: The forecast is based on current announcement and is subject to change depending on actual execution.

Source: SEMI World Fab Forecast, December 2017



## Capacity Trend in China Foundry, Memory and Discrete (LED) Fuel the Growth

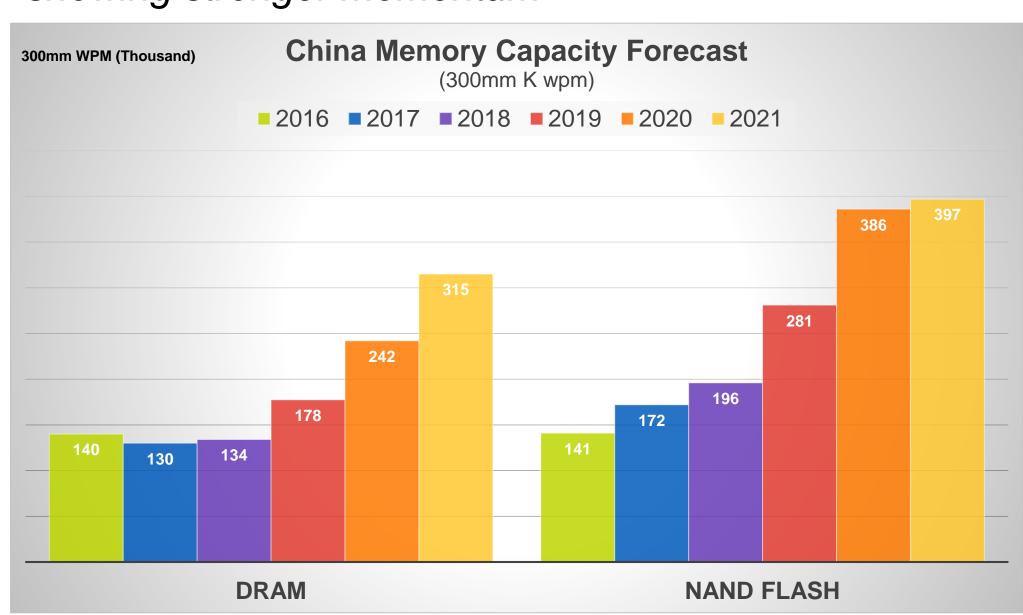


Disclaimer: The forecast is based on current announcement and is subject to change depending on actual execution.

Source: SEMI World Fab Forecast, December 2017



## Memory Capacity in China 3D NAND showing stronger momentum



Disclaimer: The forecast is based on current announcement and is subject to change depending on actual execution.

Source: SEMI World Fab Forecast, December 2017



## China Momentum and Challenges

## **Momentum**

- The surge of China investment is both policy-driven and marketdriven.
- Policies such as the National IC promotion Guidelines (2014) as well as the 13<sup>th</sup> five-year plan (2016-2020) are the key drivers of the new fab projects blossoms across the country.
- Majority of these new fab projects are supported or "invested" by National IC fund and various local government funds.
- The huge demand and rising Chinese electronics OEMs also play an important role in attracting foreign semiconductor companies to set up facilities in China.



## China Momentum and Challenges

## Challenges

- There is no shortage of capital for semiconductor fab projects in China. Though some local government funds are not really ready yet.
- Two major limiting factors are the availability of talent and the sources of technologies/IP.
- Talent sourcing is happening across Asia especially from Korea, Taiwan and Japan.
- However, talent recruiting raises some concerns about IP infringement especially in memory.
- The concerns of adding massive capacity in certain product categories may trigger oversupply in the long run.
- China faces regulatory challenges to successfully complete outbound M&A in tech sectors.









# Summary

## Fab Investment

- Record spending in 2017 and 2018
- 3D NAND, DRAM, Foundry and China investments are key drivers to spending

## The Surge of China

- 19 new projects planned from 2017 onwards.
- China is forecasted to become the largest capital equipment market in 2019
- Investment in foundry and memory segments are paving the way • for China's place on the global semiconductor stage.





# China IC Industry Outlook

## **POLICIES – ECOSYSTEM – INVESTMENTS - CAPACITIES**

- New Expanded Edition Coming in September, 2018
- Segmented Market Details
- Supply Chain Database
- Forward Analysis with
- Opportunities and Challenges





